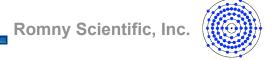


Romny Scientific, Inc.

1192 Cherry Avenue San Bruno, CA 94066

The Industrialization of Thermoelectric Power Generation Technology

Andrew Miner, Ph.D.



Company Overview

- Founded January 2007
- Developers and Manufacturers of:
 - Thermoelectric Materials
 - Modules
 - Systems

Headquarters in San Bruno, California

- Office
- Development laboratory
- Production facilities





Outline

Scientific Principles



Engineering

Useful Technology / Niche Product

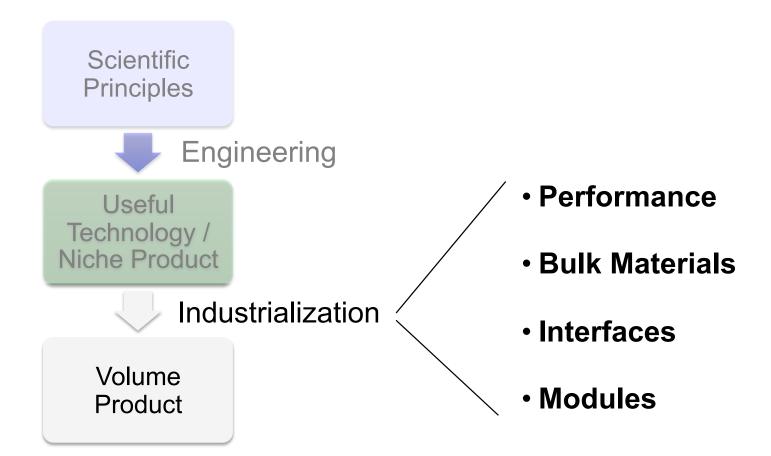


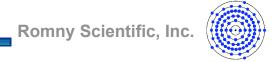
Industrialization

Volume Product



Outline





Performance in thermoelectric power generation

Performance is

ZT?

"A ZT of (insert number greater than 1) will enable (insert high volume application that thermoelectrics will dominate)"



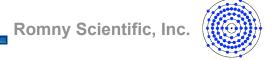
Performance in thermoelectric power generation

Performance is

ZT?

"A ZT of (insert number greater than 1) will enable (insert high volume application that thermoelectrics will dominate)"

- Power output / Cost (aka \$/Watt)
- Power output / Weight
- Power output / Volume
- Power output / Pressure Drop
- Module Efficiency
- System Efficiency
- MTBF
- Effective Module ZT
- Effective System ZT
- Etc.



Performance in thermoelectric power generation

Performance is

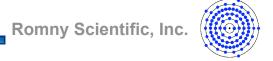
ZT?

"A ZT of (insert number greater than 1) will enable (insert high volume application that thermoelectrics will dominate)"

- Bulk Material ZT
- Electrical interface resistance
- Chemical compatibility of barriers, interfaces
- · Element thermal impedance
- Coefficient of thermal expansion
- Raw material cost
- Material production cost
- Module design / geometry
- Module manufacturing technology
- Solder / Braze technology
- Heat exchanger design
- Hot and Cold flow stream characteristics
- Application temperature ranges
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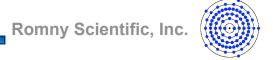
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- Bulk ZT is not power output, but can be an indicator of potential power output
- Nonlinear relationship: doubling your ZT results in less than twice the performance
- Material Production Cost is one way to look at costs.

Power output	Bulk ZT
Cost	Material Production Cost



Bulk ZT

Material Production Cost

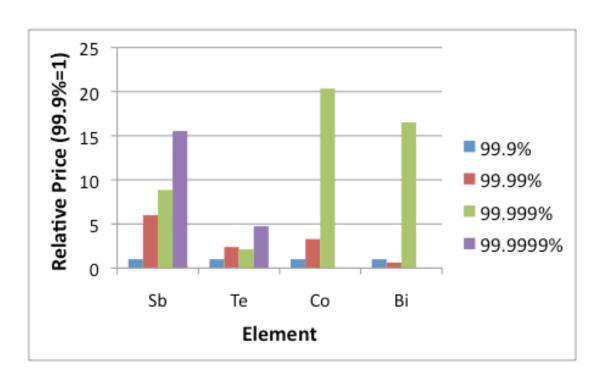
Raw Materials at What Purity?

 The lower the purity that the material system's ZT can tolerate, the lower the cost

All Impurities are not Created Equal:

 Are your impurities dopants, or inert components?

The Cost of Purity





Fidelity of Romny's ZT Measurements

Property	Measurement Method	Measurement Orientation	Measurement Range	Calibration Standard
Electrical Resist	ivity Van der Pauw	In plane	30C – 350C	NIST traceable graphite, ORNL provided BiTe
Seebeck Coeffic	ient Steady State ΔT	out of plane	30C - 350C	ORNL provided BiTe
Thermal Diffusiv	ity Flash diffusivity	In plane	30C – 300C	Netzsch Pyroceram 9606 , ORNL provided BiTe
Density	Archimedes Method Bismuth telluride standards	NA	Room temp	Pure metal standards
Heat Capacity	Color: Romny Gray: Wher Round-Robin	NA	30C-600C	Sapphire
Heat Capacity	Participants Dulong – Petit	NA	NA	NA

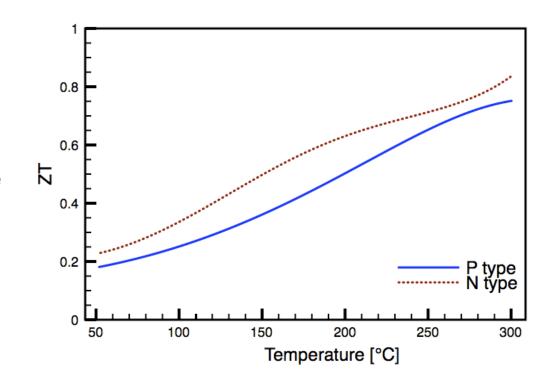
Bulk ZT

Material Production Cost

Lead Free, Tellurium Free materials for High Power / \$

•N type: Mg₂Si Based •P type: Zn₄Sb₃ Based

•All raw materials <=99.95% pure





Bulk ZT

Material Production Cost

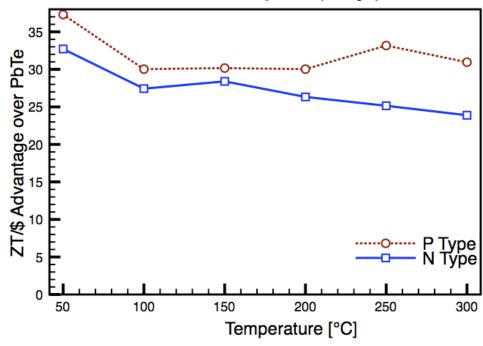
Material Production Cost Modeling Based on:

- Broad adoption in an automotive application: 4M/Yr
- · Synthesis methods scaled to volume
- Raw material pricing from global sources
- Labor
- Amortized capital equipment

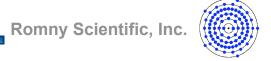
Price impact due to Global Production:

- Broad adoption (4M/Yr) of a TEG based of PbTe would consume >15% of the world tellurium production.
- Broad Adoption of these materials would consume <1% of rarest element.

Performance/Cost Advantage over PbTe for Broad Adoption (4M/yr)



2012 DOE Thermoelectric Applications Workshop, Baltimore Maryland



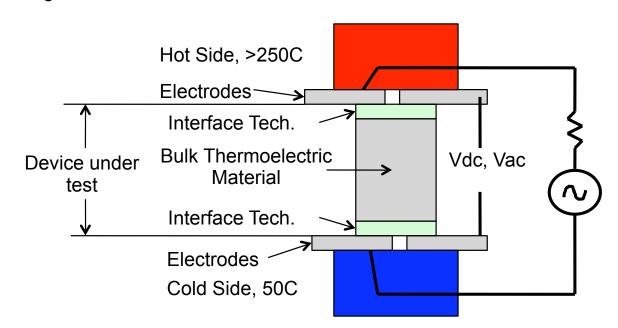
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Stability Testing of Interface Technology

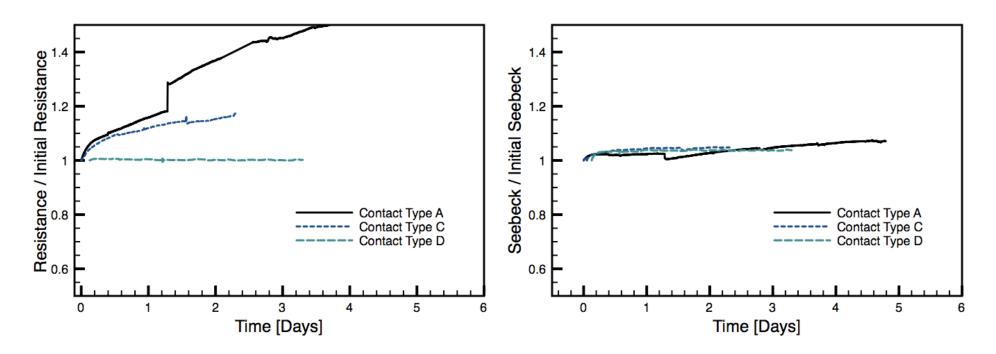
 Monitor the stability of the bulk resistance, interface resistance, and Seebeck voltage over time

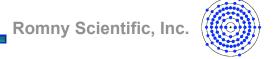




Stability Testing of Interface Technology: P-type

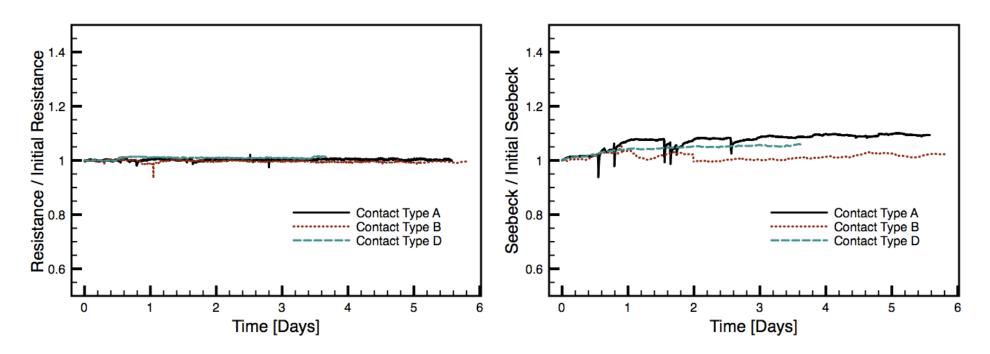
 Monitor the stability of the bulk resistance, interface resistance, and Seebeck voltage over time





Stability Testing of Interface Technology: N-type

 Monitor the stability of the bulk resistance, interface resistance, and Seebeck voltage over time





Performance Metrics Derived from Module Technology

- Bulk Material ZT
- Electrical interface resistance
- Chemical compatibility of barriers, interfaces
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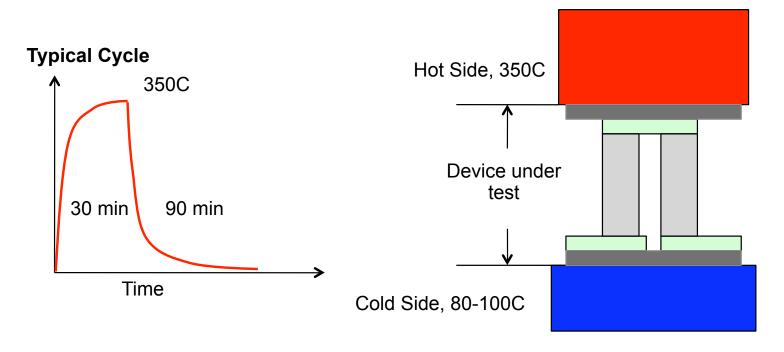
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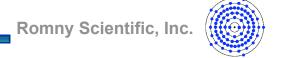


Performance Metrics Derived from Module Technology

Stability Testing of Modules Technology

• Temperature cycle modules, monitor circuit electrical resistance

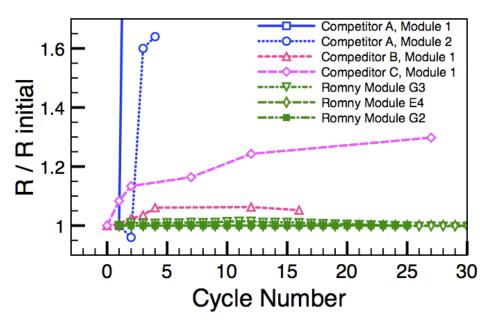


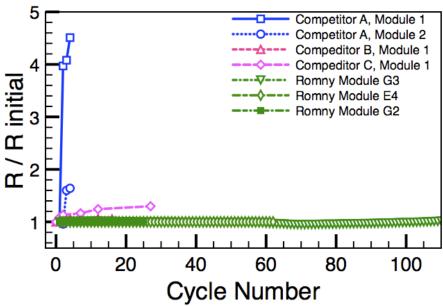


Performance Metrics Derived from Module Technology

Stability Testing of Modules Technology

• Temperature cycle modules, monitor circuit electrical resistance





Conclusion

- To develop TEG systems for broad market adoption, it is important to develop TEGs considering the sellable metrics of TEG systems.
- Romny has developed the foundations for volume scalable TEGs by demonstrating:
 - Lead free materials
 - Tellurium free materials
 - Materials that do not require high purity feed stock
 - High performance/\$ materials
 - Contact technology for these materials
 - Robust device technology for TEGs

Acknowledgements

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